# 40 V, 17 A P-channel Trench Power MOSFET with Reverse Battery Protection

# **DJR0417**



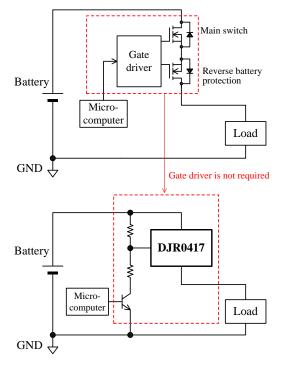
## **Description**

DJR0417 is P-channel trench power MOSFET designed for the load switch of automotive electronic units requiring the reverse battery protection. Since DJR0417 has a bidirectional diode between Drain and Source, the reverse battery protection can be realized with only one load switch.

#### **Features**

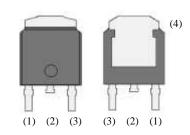
- $R_{DS(ON)}$  ----- 75 m $\Omega$  max. (ID = -8.5 A, VGS = -10 V)
- Automotive Qualified
- Load switch can configure by only one component
- For reverse battery protection
- Compliant with RoHS Directive

# **Typical Application**



## **Package**

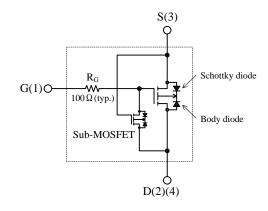
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- (1) Gate
- (2)(4) Drain
- (3) Source

Not to Scale

#### **Equivalent circuit**



## **Application**

• Car battery

## **Absolute Maximum Ratings**

• Unless otherwise specified,  $T_A = 25$  °C

Parameter	Symbol	Test conditions	Rating	Unit
Drain to Source Voltage	$V_{DS}$		- 40	V
Source to Drain Voltage	$V_{SD}$		- 16	V
Gate to Source Voltage	$V_{GS}$		- 15,+ 0	V
Continuous Drain Current	$I_D$	T <sub>C</sub> = 25 °C	- 17	A
Single Pulse Avalanche Energy	E <sub>AS</sub>	$V_{DD} = -15 \text{ V}, L = 1 \text{ mH},$ $I_{AS} = -17 \text{ A}, \text{ unclamped},$ Refer to Figure 1	230	mJ
Power Dissipation	$P_{D}$	$T_C = 25  ^{\circ}C$	48	W
Operating Junction Temperature	$T_{J}$		- 55 to 150	°C
Storage Temperature Range	$T_{STG}$		- 55 to 150	°C
Maximum Drain to Source dv/dt	dv/dt		0.075	V/ns

## **Thermal Characteristics**

• Unless otherwise specified,  $T_A = 25 \, ^{\circ}C$ 

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Thermal Resistance (Junction to Case)	$R_{ heta JC}$		-	_	2.6	°C/W

## **Electrical Characteristic**

• Unless otherwise specified,  $T_A = 25$  °C

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain to Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$I_D = -100 \mu A, V_{GS} = 0 V$	- 40	_	_	V
Drain to Source Leakage Current	$I_{DSS}$	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	- 100	μΑ
Gate to Source Leakage Current	$I_{GSS}$	$V_{GS} = -15 \text{ V}$	_	_	- 100	μA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	- 1.0	- 1.75	- 2.5	V
Static Drain to Source On-Resistance	R <sub>DS(ON)</sub>	$I_D = -8.5 \text{ A}, V_{GS} = -10 \text{ V}$	_	50	75	mΩ
		$I_D = -5 \text{ A}, V_{GS} = -4.5 \text{ V}$	_	130	350	$m\Omega$
Total Gate Charge (V <sub>GS</sub> = 10 V)	$Q_{\mathrm{g}}$	$V_{DS} = -15 \text{ V}$	_	75	_	
Gate to Source Charge	$Q_{\mathrm{gs}}$	$I_D = -8.5 \text{ A}$	_	9	_	nC
Gate to Drain Charge	$Q_{\mathrm{gd}}$	$V_{GS} = -10 \text{ V}$	_	30	_	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{\rm DD} = -15 \text{ V}$	_	90	_	
Rise Time	t <sub>r</sub>	$I_D = -8.5 \text{ A}$ $R_G = 10 \Omega, R_L = 1.53 \Omega,$	_	450	_	
Turn-Off Delay Time	$t_{d(off)}$	$R_{GS} = 50 \Omega$	_	990	_	ns
Fall Time	$t_{\mathrm{f}}$	$V_{GS} = -10 \text{ V}$ Refer to Figure 2	_	910	_	
Source to Drain Breakdown Voltage	$V_{(BR)SD}$	$I_S = -1 \text{m A}, V_{GS} = 0 \text{ V}$	- 16	_	_	V

## **Test Circuits and Waveforms**

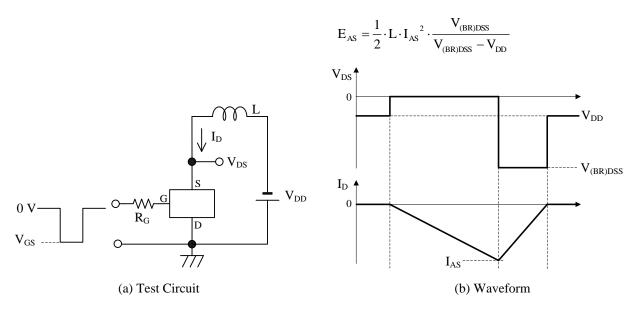


Figure 1 Unclamped Inductive Switching

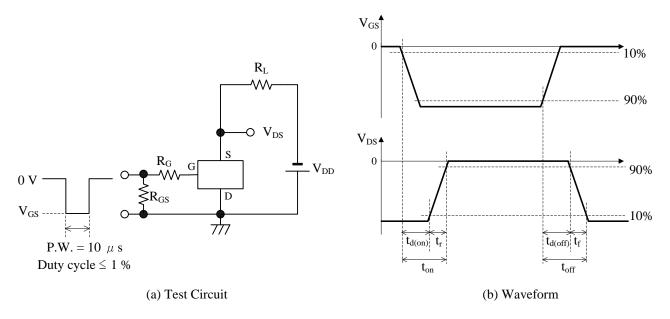
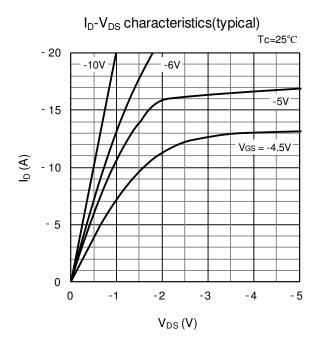
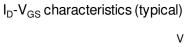
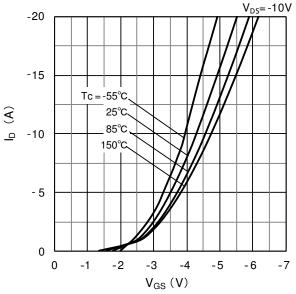


Figure 2 Switching Time

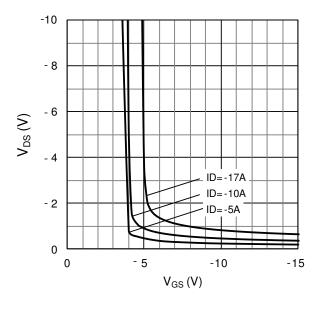
#### **Performance Curves**



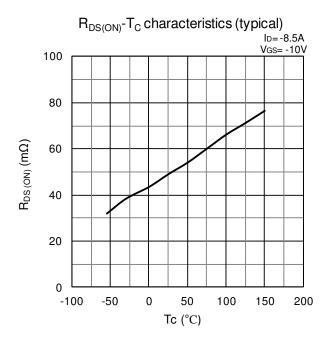


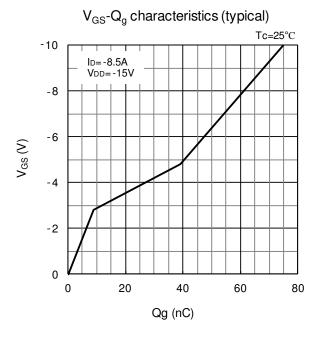


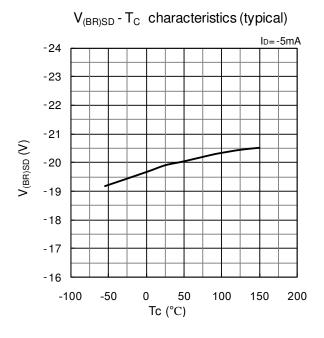
V<sub>DS</sub> - V<sub>GS</sub> characteristics (typical)

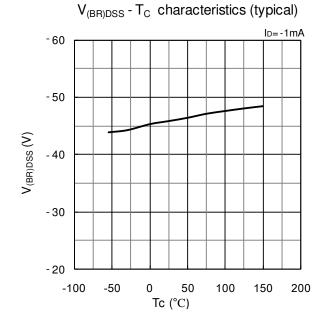


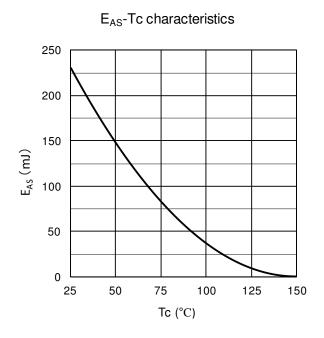
 $V_{th} - T_{C} \text{ characteristics (typical)} \\ V_{DS=-10V} \\ I_{D=-1mA} \\ -2.0 \\ -2.0 \\ -1.5 \\ -1.0 \\ -0.5 \\ -100 \\ -50 \\ 0 \\ 50 \\ 100 \\ 150 \\ 200 \\ Tc (^{\circ}C)$ 

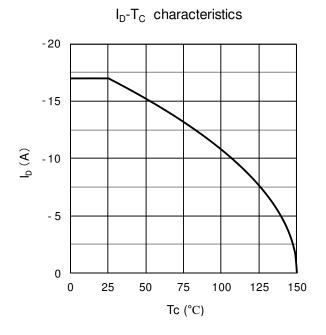


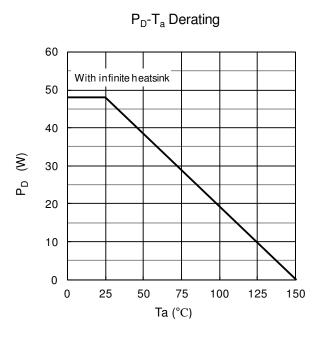


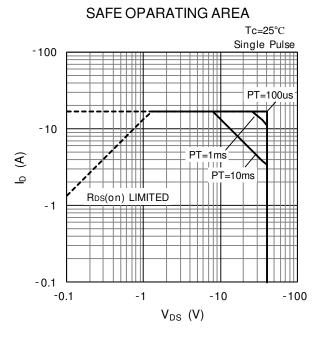


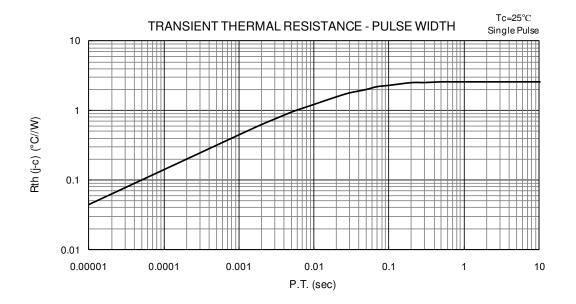






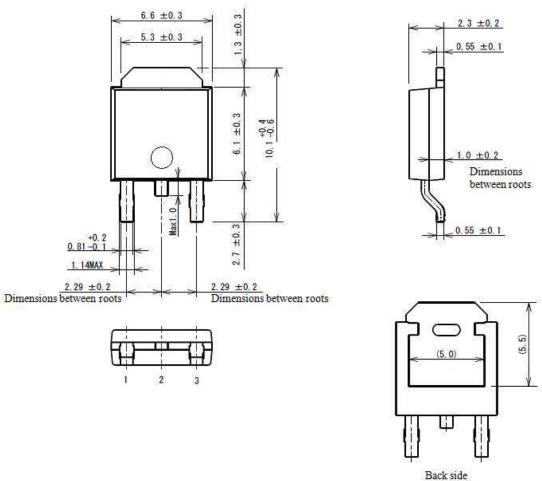






#### **External Dimensions**

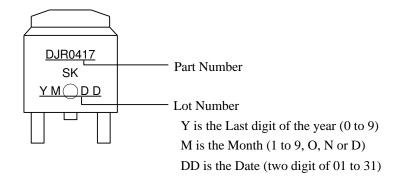
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#### **NOTES:**

- Dimension is in millimeters
- Pb-free. Device composition compliant with the RoHS directive

## **Marking Diagram**



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